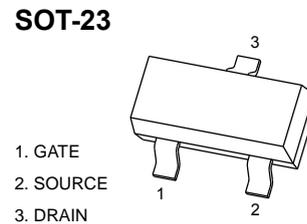
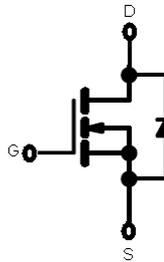
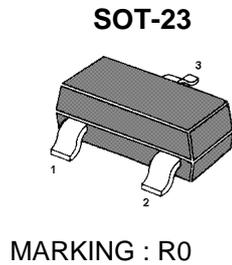


N-Channel MOSFET


FEATURE

- High dense cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

APPLICATION

- Load/Power Switching
- Interfacing Switching

$V_{(BR)DSS}$	$R_{DS(on)Typ}$	I_D
30 V	31m Ω @ 10V	5.8A
	35m Ω @4.5V	
	50m Ω @2.5V	

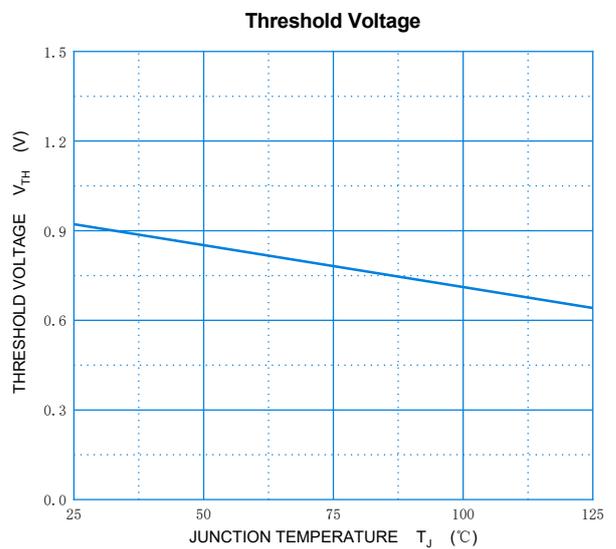
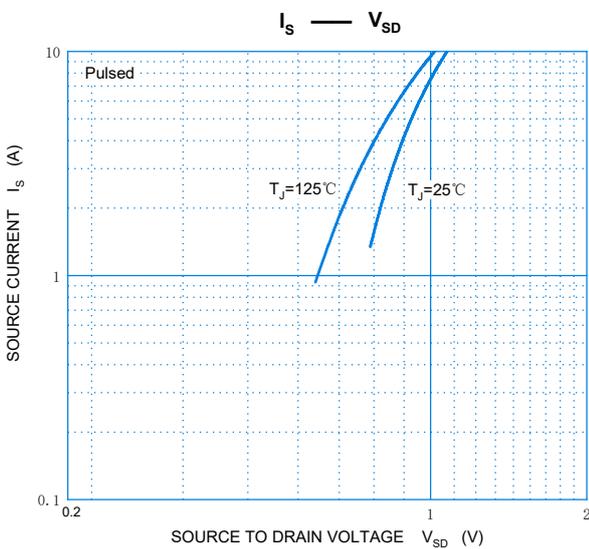
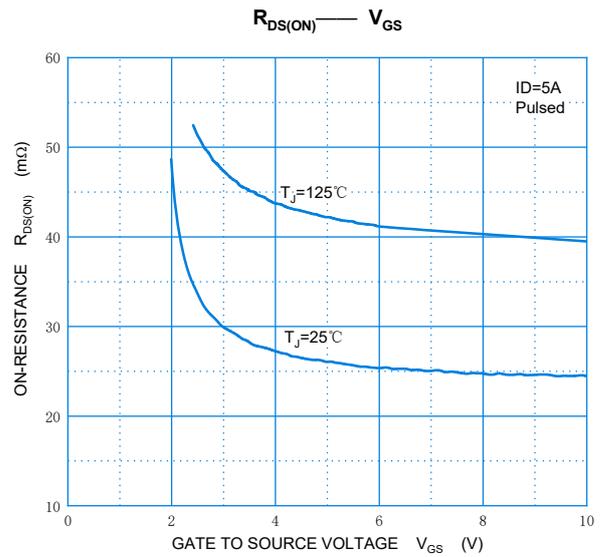
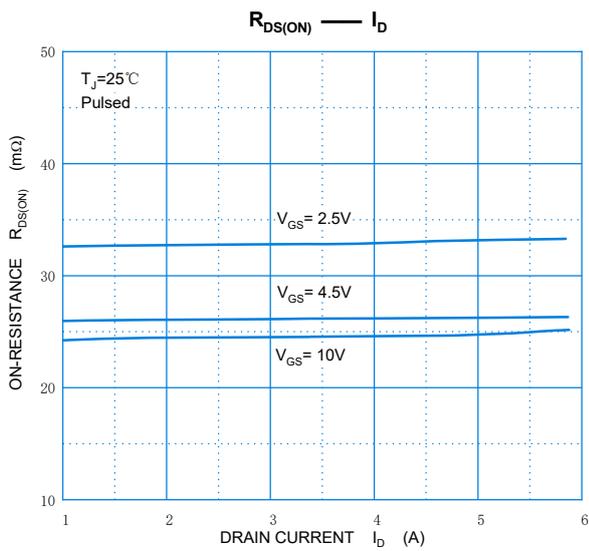
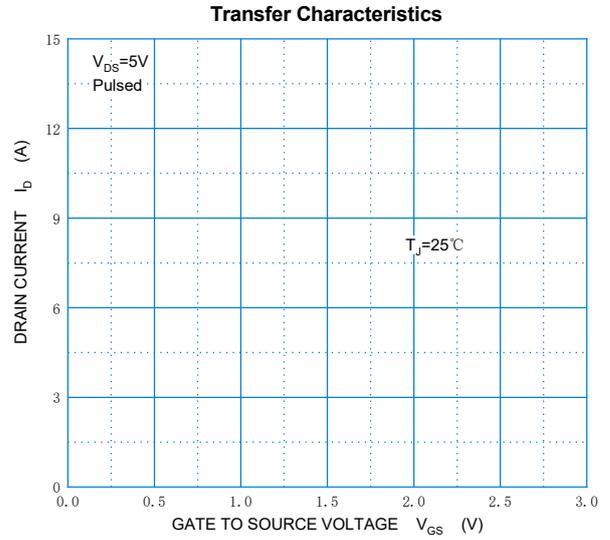
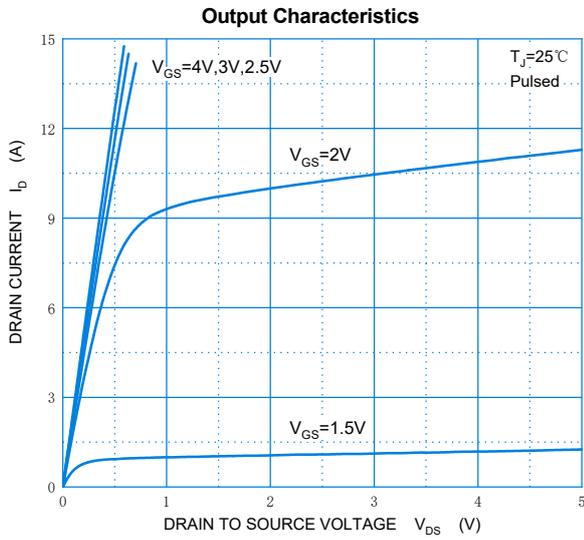
Maximum ratings ($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current	I_D	5.8	A
Drain Current-Pulsed ^①	I_{DM}	22	A
Power Dissipation	P_D	1.4	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	130	$^{\circ}\text{C}/\text{W}$
Operation Junction and Storage Temperature Range	T_J, T_{STG}	-55~+150	$^{\circ}\text{C}$

$T_a=25\text{ }^\circ\text{C}$ unless otherwise specified

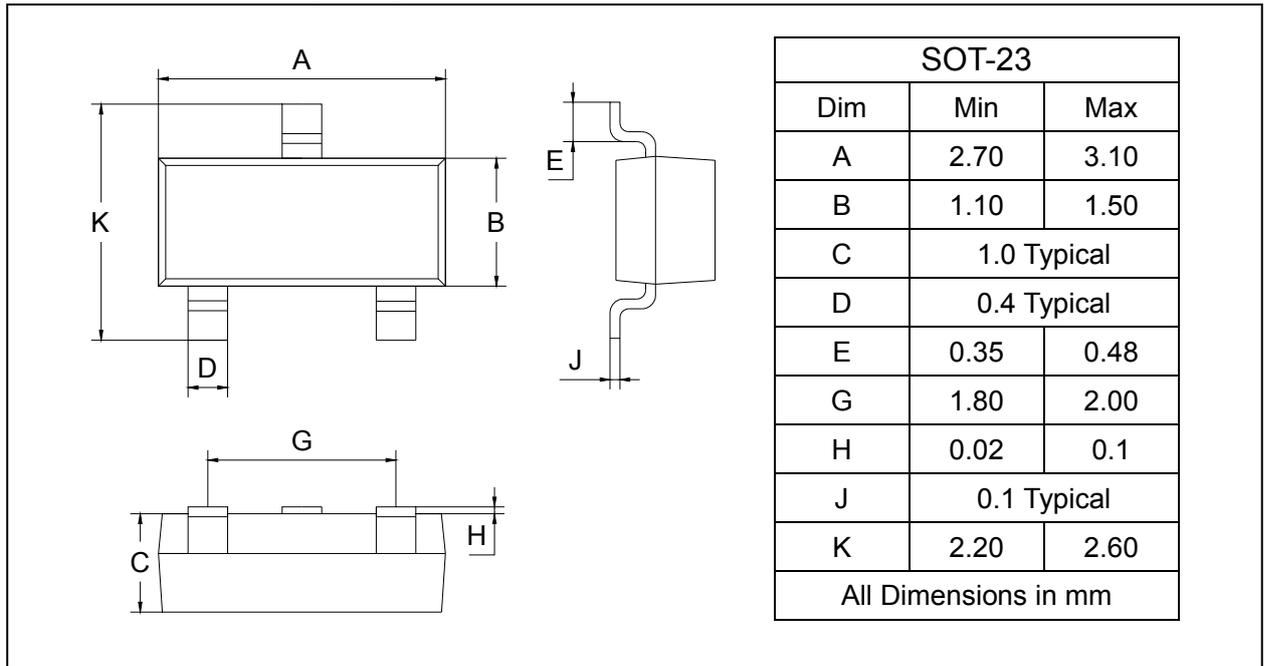
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	30			V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 24V, V_{GS} = 0V, T_J = 25\text{ }^\circ\text{C}$			1	μA
		$V_{DS} = 24V, V_{GS} = 0V, T_J = 125\text{ }^\circ\text{C}$			1	mA
Gate-source leakage current	I_{GSS}	$V_{GS} = \pm 12V, V_{DS} = 0V$			± 100	nA
On characteristics						
Drain-source on-resistance ^②	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 4A$		31	40	m Ω
		$V_{GS} = 4.5V, I_D = 3A$		35	46	m Ω
		$V_{GS} = 2.5V, I_D = 2A$		50	70	m Ω
Forward transconductance	g_{FS}	$V_{DS} = 5V, I_D = 5A$	8			S
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.7	0.9	1.4	V
Dynamic Characteristics ^③						
Input capacitance	C_{iss}	$V_{DS} = 15V, V_{GS} = 0V, f = 1MHz$		820	1050	pF
Output capacitance	C_{oss}			99		pF
Reverse transfer capacitance	C_{riss}			77		pF
Gate resistance	R_g	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$		3.6		Ω
Switching Characteristics ^③						
Turn-on delay time	$t_{d(on)}$	$V_{GS} = 10V, V_{DS} = 15V,$ $R_L = 2.7\Omega, R_{GEN} = 3\Omega$		3.3	5	ns
Turn-on rise time	t_r			4.8	7	ns
Turn-off delay time	$t_{d(off)}$			26	40	ns
Turn-off fall time	t_f			4	6	ns
Total Gate Charge	Q_g	$V_{DS} = 10V, I_D = 5A,$ $V_{GS} = 6V$		9.5		nC
Gate-Source Charge	Q_{gs}			1.5		nC
Gate-Drain Charge	Q_{gd}			3		nC
Drain-source diode characteristics and maximum ratings						
Diode forward voltage ^②	V_{SD}	$I_S = 1A, V_{GS} = 0V$			1	V
Continuous drain-source diode forward current	I_S				5.8	A
Pulsed drain-source diode forward current ^①	I_{SM}				22	A

Typical Characteristics

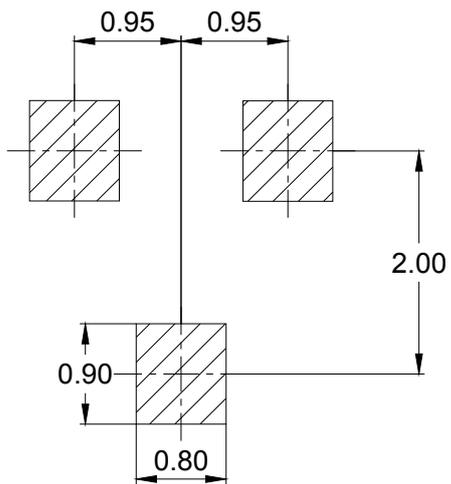


Plastic surface mounted package

SOT-23



SOLDERING FOOTPRINT



Unit : mm